

## N-channel Enhancement Mode Power MOSFET

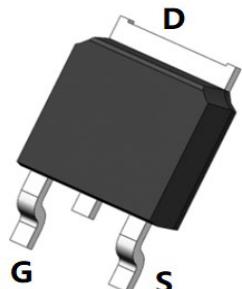
### Features

- $V_{DS} = 150V$ ,  $I_D = 20A$
- $R_{DS(ON)} < 70\text{ m}\Omega @ V_{GS} = 10V$
- $R_{DS(ON)} < 80\text{ m}\Omega @ V_{GS} = 4.5V$

### General Features

- Advanced Trench Technology
- Provide Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free and Green Available

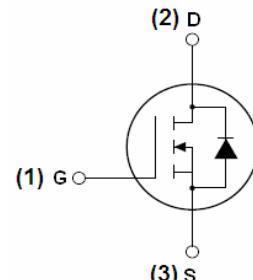
100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



TO-252-2L Top View



Pin Assignment



Schematic Diagram

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage	150	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current-Continuous	20	A
$I_D (100^\circ\text{C})$	Drain Current-Continuous( $T_C=100^\circ\text{C}$ )	14	A
$I_{DM}$	Pulsed Drain Current	40	A
$P_D$	Maximum Power Dissipation	90	W
	Derating factor	0.6	W/ $^\circ\text{C}$
$E_{AS}$	Single pulse avalanche energy <sup>(Note 5)</sup>	80	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	$^\circ\text{C}$

### Thermal Characteristic

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	1.7	$^\circ\text{C}/\text{W}$
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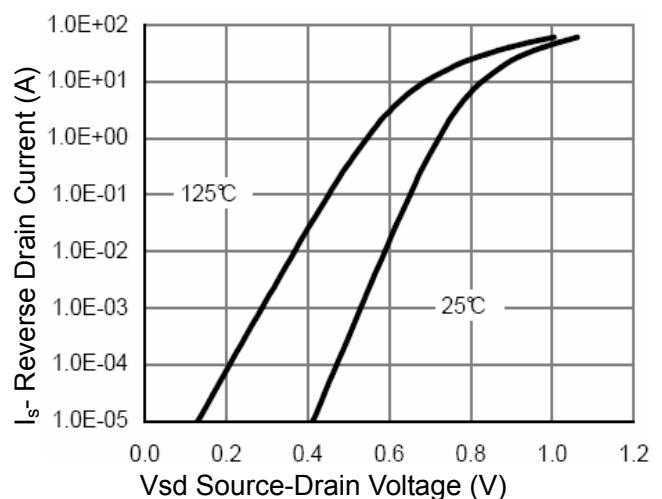
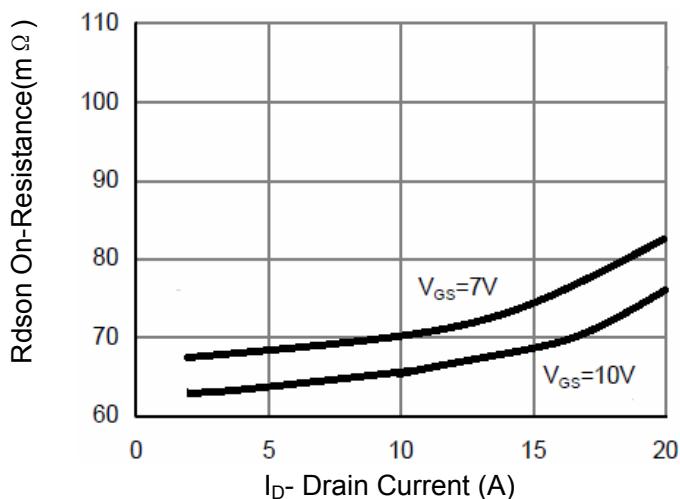
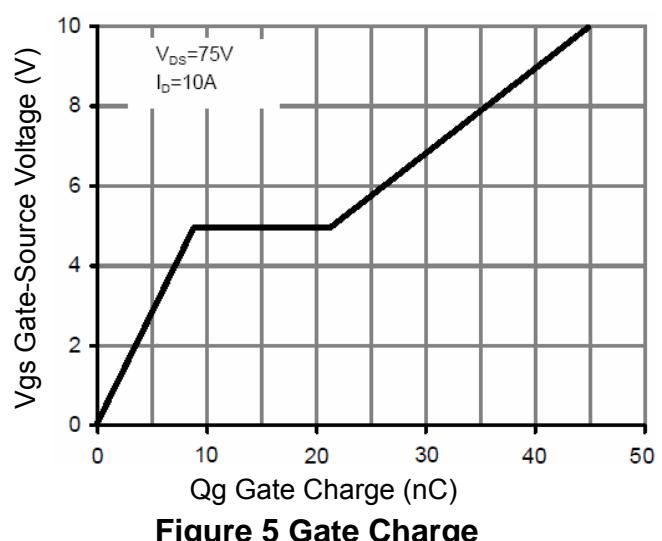
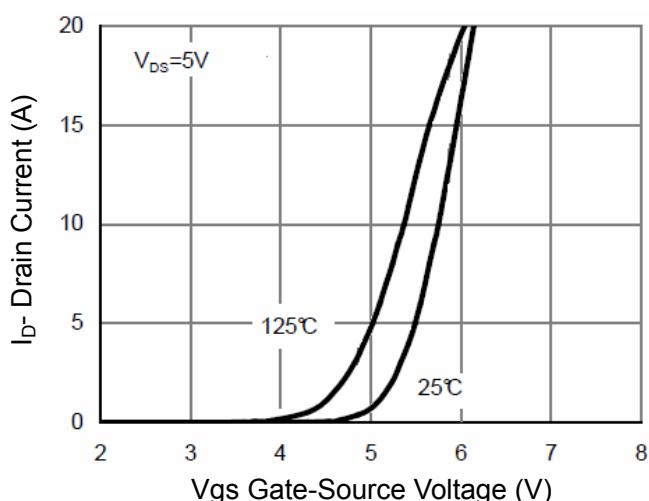
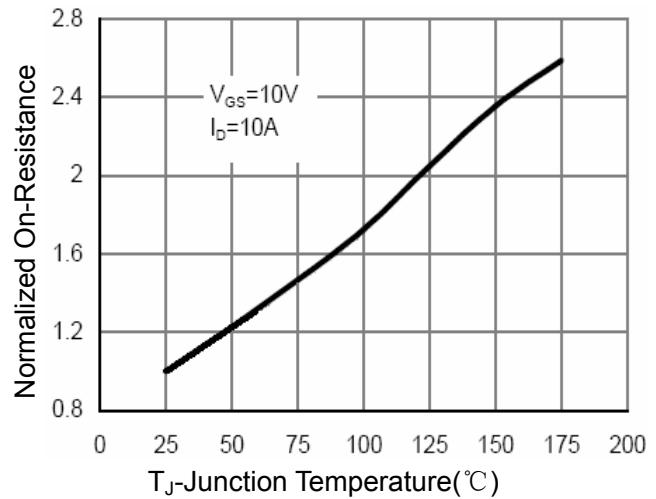
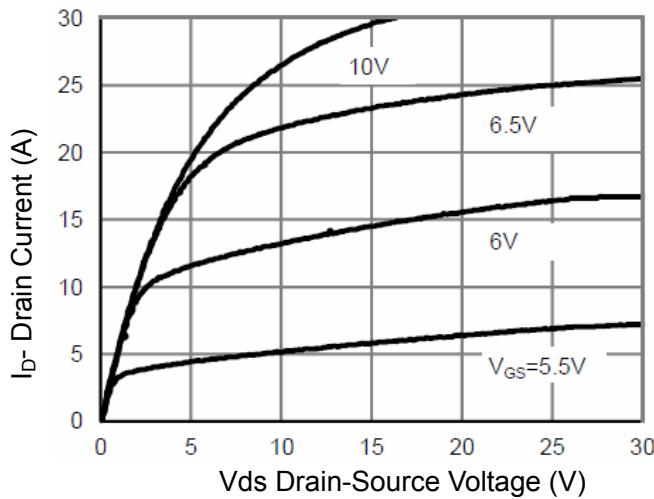
**Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

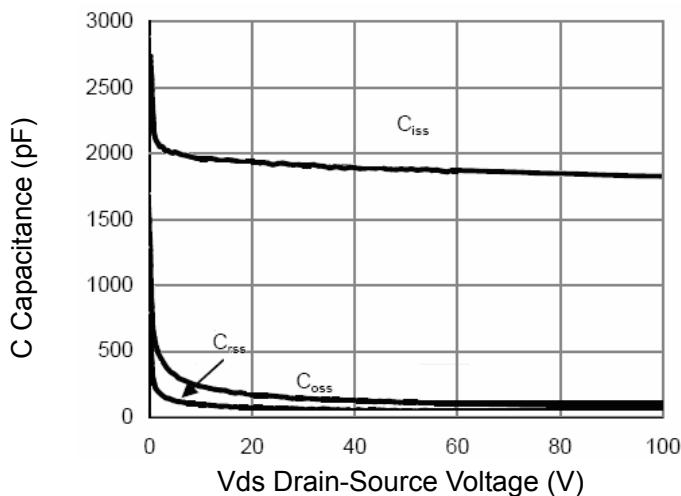
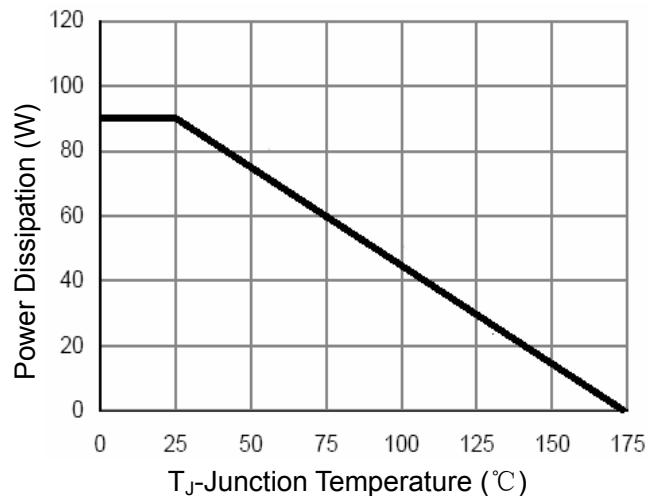
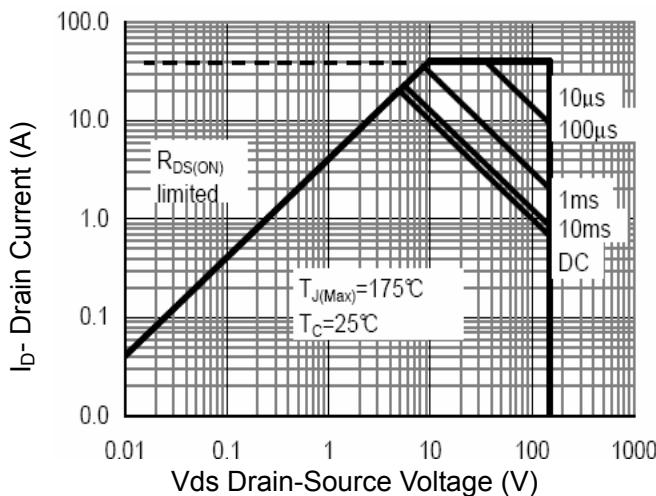
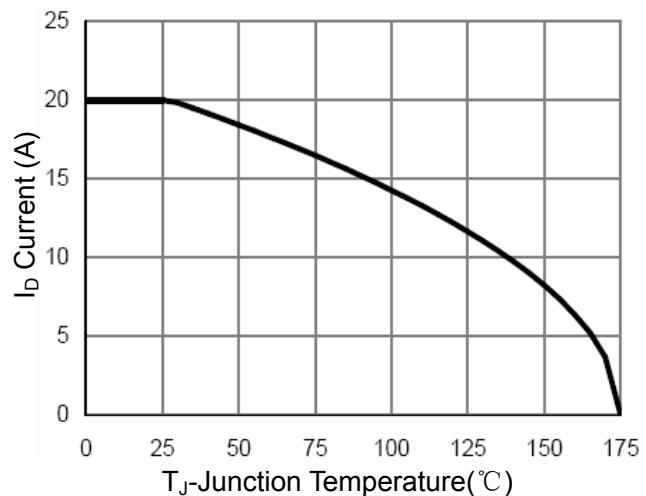
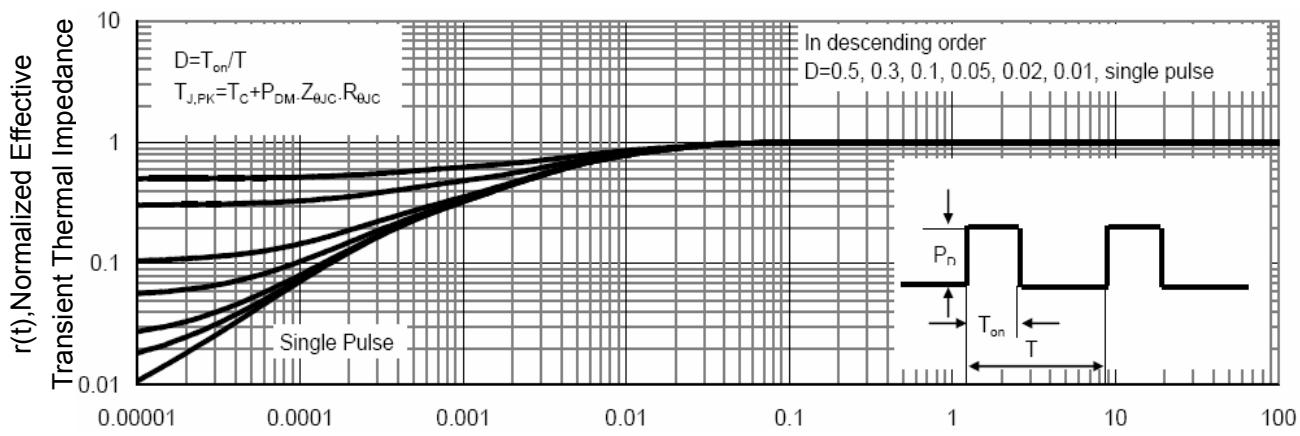
Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	150	165	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=150\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	4	-	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=10\text{A}$	-	70	$\text{m}\Omega$	
		$V_{\text{GS}}=7\text{V}, I_{\text{D}}=10\text{A}$		80		
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{D}}=10\text{A}$	-	20	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=75\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	1810	-	PF
$C_{\text{oss}}$	Output Capacitance		-	61	-	PF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	45	-	PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DD}}=75\text{V}, R_{\text{L}}=5\Omega, V_{\text{GS}}=10\text{V}, R_{\text{GEN}}=3\Omega$	-	15.5	-	nS
$t_{\text{r}}$	Turn-on Rise Time		-	8.5	-	nS
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		-	19.5	-	nS
$t_{\text{f}}$	Turn-Off Fall Time		-	7	-	nS
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{DS}}=75\text{V}, I_{\text{D}}=10\text{A}, V_{\text{GS}}=10\text{V}$	-	45	-	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	9	-	nC
$Q_{\text{gd}}$	Gate-Drain Charge		-	12	-	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{\text{SD}}$	Diode Forward Voltage <sup>(Note 3)</sup>	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$	-	-	1.2	V
$I_{\text{S}}$	Diode Forward Current <sup>(Note 2)</sup>	-	-	-	20	A
$t_{\text{rr}}$	Reverse Recovery Time	$T_J = 25^\circ\text{C}, IF = 10\text{A}$ $di/dt = 100\text{A}/\mu\text{s}$ <sup>(Note 3)</sup>	-	32	-	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		-	53	-	nC
$t_{\text{on}}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
  2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
  3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
  4. Guaranteed by design, not subject to production
5. EAS condition:  $T_j=25^\circ\text{C}, V_{\text{DD}}=50\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$

### Typical Electrical and Thermal Characteristics (Curves)



**Figure 7 Capacitance vs Vds****Figure 9 Power De-rating****Figure 8 Safe Operation Area****Figure 10 ID Current- Junction Temperature****Figure 11 Normalized Maximum Transient Thermal Impedance**